Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK2662

DC-DC Converter, Relay Drive and Motor Drive Applications

• Low drain–source ON resistance : R_{DS} (ON) = 1.35 Ω (typ.)

• High forward transfer admittance : $|Y_{fs}| = 4.0 \text{ S (typ.)}$

• Low leakage current : $IDSS = 100 \mu A (max) (VDS = 500 V)$

• Enhancement-mode : $V_{th} = 2.0 \sim 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	500	V
Drain-gate voltage (R	$GS = 20 \text{ k}\Omega$)	V_{DGR}	500	V
Gate-source voltage		V _{GSS}	±30	V
Drain current	DC (Note 1)	I _D	5	Α
	Pulse (Note 1)	I _{DP}	20	Α
Drain power dissipatio	n (Tc = 25°C)	PD	35	W
Single pulse avalanch	e energy (Note 2)	E _{AS}	180	mJ
Avalanche current		I _{AR}	5	Α
Repetitive avalanche	energy (Note 3)	E _{AR}	3.5	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature r	ange	T _{stg}	-55~150	°C

10±0.3 63.2±0.2 2.7±0.2 2.7±0.2 2.54±0.25 2.54

Weight: 1.9 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.57	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 12.2 mH, $R_G = 25 \Omega$, $I_{AR} = 5 \text{ A}$

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device.

Please handle with caution.



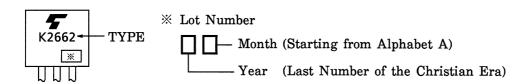
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bro	eakdown voltage	V (BR) GSS	$I_G = \pm 10 \mu\text{A}, V_{DS} = 0 \text{V}$	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	_	_	V
Gate threshold v	/oltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 2.5 A	_	1.35	1.50	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	2.5	4.0	_	S
Input capacitano	capacitance C _{iss}			_	780	_	pF
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	60	_	
Output capacitance		Coss		_	200	_	
Switching time	Rise time	t _r	$V_{GS} = V_{OU}$ $V_{GS} = V_{OU}$ $V_{DD} = 2.5A$ V_{OU} $V_{DD} = 225V$	_	12	_	
	Turn-on time	t _{on}		_	25	_	no
	Fall time	t _f		_	15	_	- ns -
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu \rm s$	_	60	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	17	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		11		nC
Gate-drain ("miller") Charge		Q _{gd}			6		

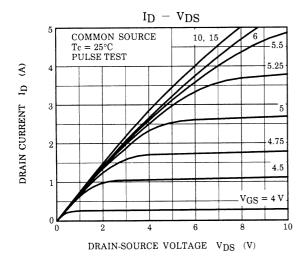
Source-Drain Ratings and Characteristics (Ta = 25°C)

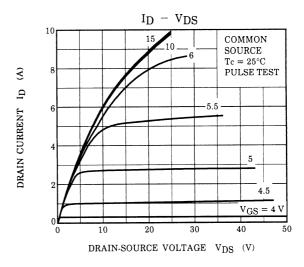
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	5	Α
Pulse drain reverse current (Note 1)	I _{DRP}		_	_	20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 5 A, V _{GS} = 0 V		1400	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} / dt = 100 A / μs	_	9	_	μC

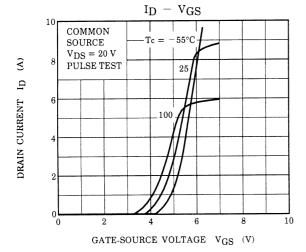
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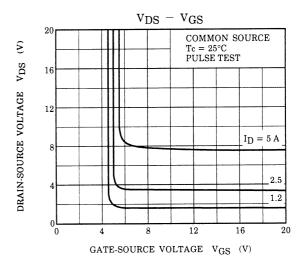


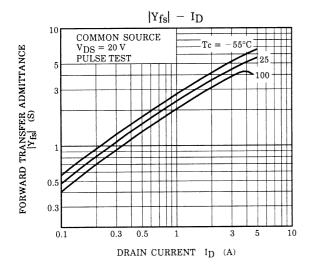
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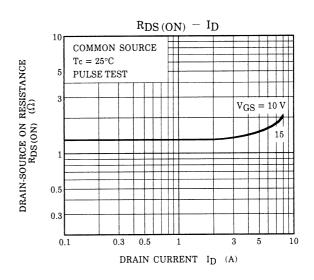




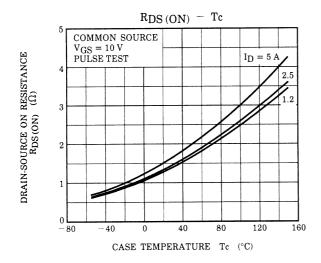


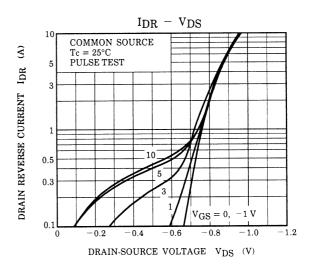


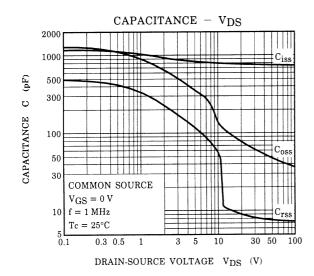


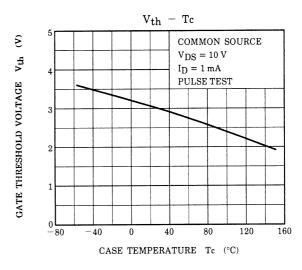


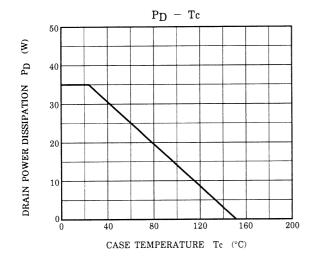
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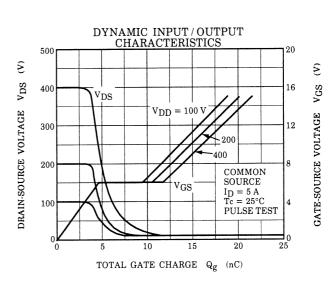




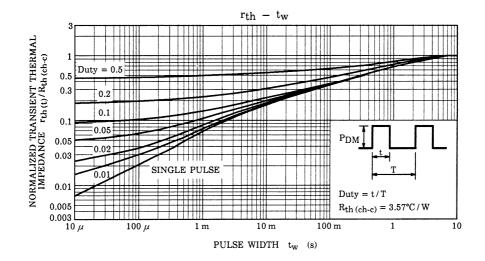


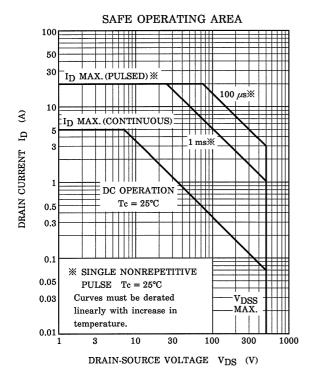


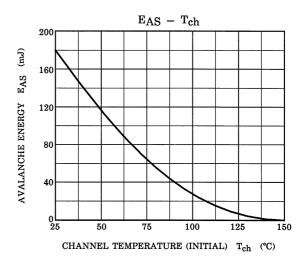


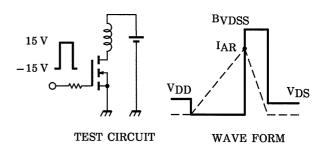


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$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 90~V,~L = 12.2~mH \end{aligned} \quad E_{AS} &= \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right) \end{aligned}$$

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